

## ABSTRACT

This user guide describes the operational use of the TPS38700Q1EVM evaluation module (EVM) as a reference design for engineering demonstration and evaluation of the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#). This guide contains the EVM schematic, bill of materials (BOM), assembly drawing, and top and bottom board layouts.

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**Trademarks**

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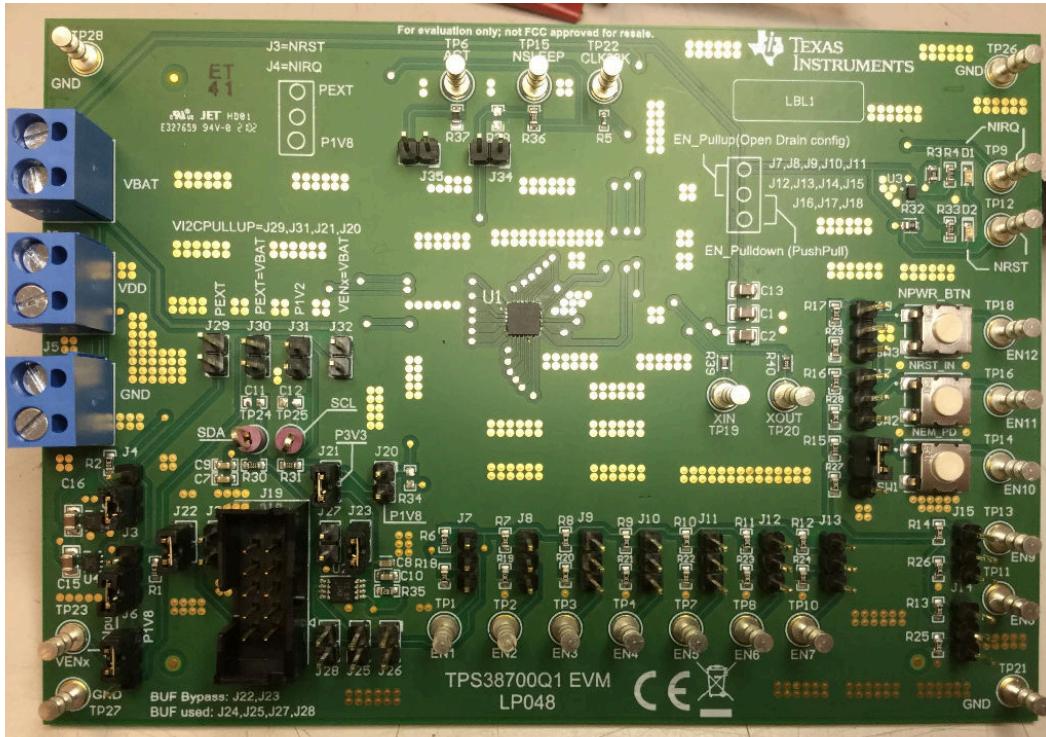
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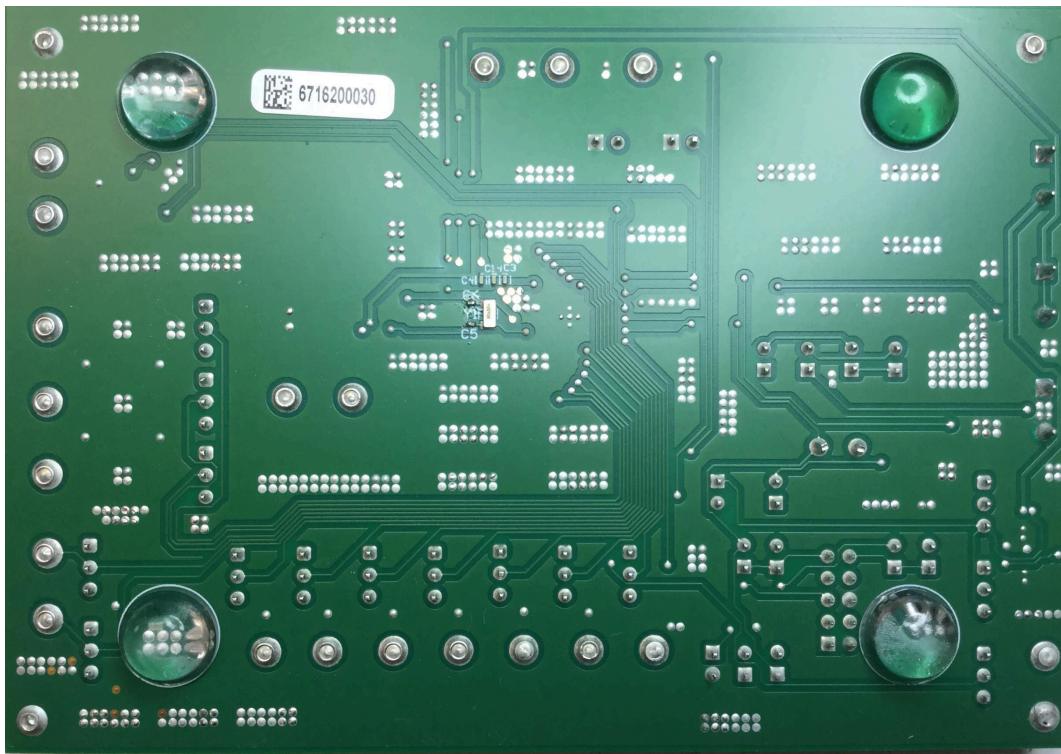
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## 1 Introduction

The TPS38700Q1EVM is an evaluation module (EVM) for the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#). Test points are provided to give the user additional access, if needed, for oscilloscope or multi-meter measurements.

The TPS38700Q1EVM comes pre-populated with TPS38700C03NRGERQ1. This option offers NEM\_PD pin which allow the system to issue an emergency power down while also being able to sequence up to ten different devices all with a precise predefined sequence. The device also offers the option of battery backup power, a precise 32.768 kHz clock, and the ability to communicate faults via I2C. ACT and SLEEP pins allow for the device to change state depending on the logic level present on each. The NIRQ pin serves as an interrupt flag to alert the system to possible faults, and the NRST pin asserts logic high under reset condition.





**Figure 1-2. TPS38700Q1EVM Board Bottom**

## 1.1 Related Documentation

Datasheet: [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#)

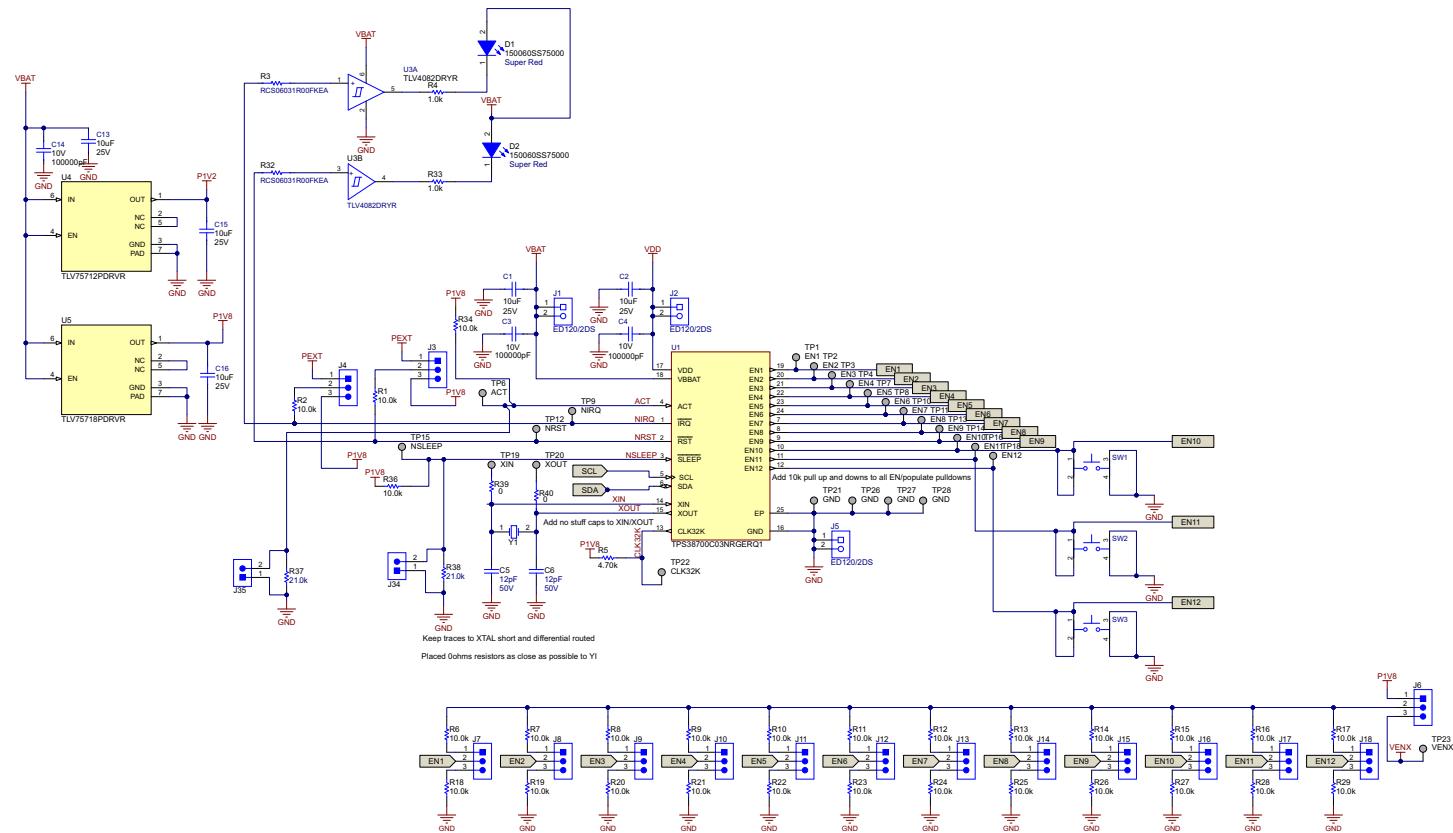
## 1.2 TPS38700-Q1 Applications

- Advanced Driver Assistance System (ADAS)
- Medical robotics
- Industrial robotics

## 2 Schematic, Bill of Materials, and Layout

This section provides a detailed description of the TPS38700Q1EVM schematic, bill of materials (BOM), and layout.

## 2.1 TPS38700Q1EVM Schematic



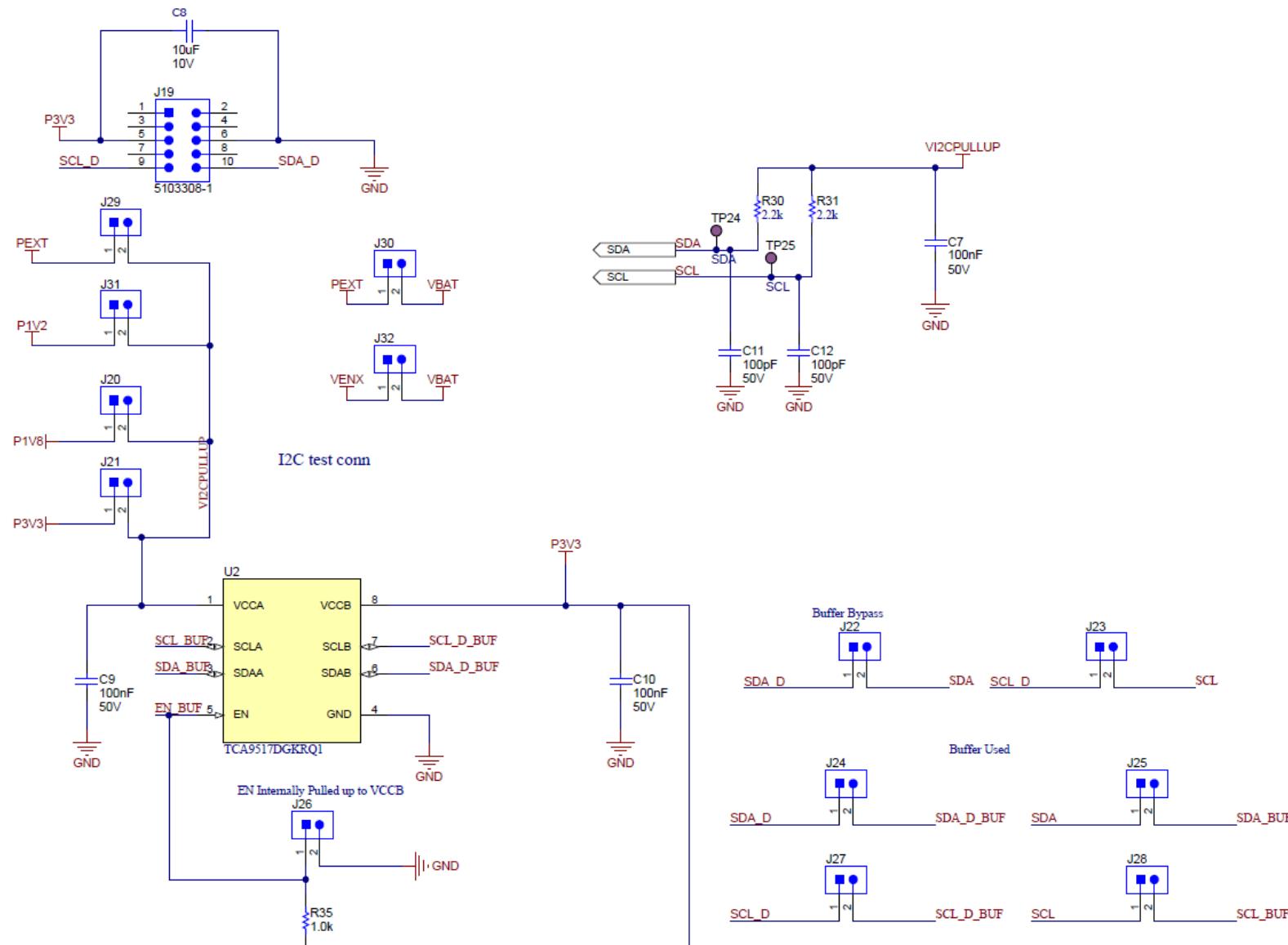


Figure 2-2. TPS38700Q1EVM Schematic 2 of 2

## 2.2 TPS38700Q1EVM Bill of Materials

**Table 2-1. BOM**

| DESIGNATOR   | QTY | VALUE           | DESCRIPTION   | PACKAGE<br>REFERENCE | PART NUMBER         | MANUFACTURER        |
|--|-----|-----------------|---|----------------------|---------------------|---------------------|
| PCB  | 1   |                 | Printed Circuit Board   |                      | LP048               | Any                 |
| C1, C2, C13,<br>C15, C16   | 5   | 10 $\mu$ F      | 10 $\mu$ F $\pm$ 10% 25 V Ceramic Capacitor X7S 0805 (2012 Metric)  | 0805                 | C2012X7S1E106K125AC | TDK                 |
| C3, C4, C14  | 3   | 0.1 $\mu$ F     | 0.1 $\mu$ F $\pm$ 10% 10 V Ceramic Capacitor X7R 0402 (1005 Metric)   | 0402                 | 885012205018        | Wurth Electronics   |
| C5, C6   | 2   | 12 pF           | CAP, CERM, 12 pF, 50 V, +/- 5%, C0G/NP0, 0201   | 0201                 | GRM0335C1H120JA01D  | MuRata              |
| C7, C9, C10  | 3   | 0.1 $\mu$ F     | CAP, CERM, 0.1 $\mu$ F, 50 V, +/- 10%, X7R, 0603  | 0603                 | 06035C104KAT2A      | AVX                 |
| C8   | 1   | 10 $\mu$ F      | 10 $\mu$ F $\pm$ 10% 10 V Ceramic Capacitor X5R 0603 (1608 Metric)  | 0603                 | C1608X5R1A106K080AC | TDK                 |
| C11, C12   | 2   | 100 pF          | CAP, CERM, 100 pF, 50 V, +/- 5%, C0G/NP0, 0603  | 0603                 | 06035A101JAT2A      | AVX                 |
| D1, D2   | 2   | Red             | LED, Super Red, SMD   | SMD                  | 150060SS75000       | Wurth Elektronik    |
| FID1, FID2, FID3   | 3   |                 | Fiducial mark. There is nothing to buy or mount.  |                      | N/A                 | N/A                 |
| H1, H2, H3, H4   | 4   |                 | Bumpon, Hemisphere, 0.44 X 0.20, Clear  |                      | SJ-5303 (CLEAR)     | 3M                  |
| J1, J2, J5   | 3   |                 | Terminal Block, 5.08 mm, 2x1, Brass, TH   | 2x1 TH               | ED120/2DS           | On-Shore Technology |
| J3, J4, J6, J7, J8,<br>J9, J10, J11, J12,<br>J13, J14, J15,<br>J16, J17, J18   | 15  |                 | Header, 100mil, 3x1, Gold, TH   | 3x1 TH               | TSW-103-07-G-S      | Samtec              |
| J19  | 1   |                 | Header (shrouded), 100mil, 5x2, Gold, TH  | 5x2 TH               | 5103308-1           | TE Connectivity     |
| J20, J21, J22,<br>J23, J24, J25,<br>J26, J27, J28,<br>J29, J30, J31,<br>J32, J34, J35  | 15  |                 | Header, 100mil, 2x1, Gold, TH   | 2x1 TH               | TSW-102-07-G-S      | Samtec              |
| LBL1   | 1   |                 | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll  |                      | THT-14-423-10       | Brady               |
| R1, R2, R6, R7,<br>R8, R9, R10,<br>R11, R12, R13,<br>R14, R15, R16,<br>R17, R18, R19,<br>R20, R21, R22,<br>R23, R24, R25,<br>R26, R27, R28,<br>R29 | 26  | 10.0 k $\Omega$ | RES, 10.0 k $\Omega$ , 1%, 0.1 W, 0603  | 0603                 | RC0603FR-0710KL     | Yageo               |
| R3, R32  | 2   | 1 $\Omega$      | 1 $\Omega$ $\pm$ 1% 0.25 W, 1/4 W Chip Resistor 0603 (1608 Metric) Automotive AEC-Q200, Pulse Withstanding Thick Film | 0603                 | RCS06031R00FKEA     | Vishay              |
| R4, R33  | 2   | 1.0 k $\Omega$  | RES, 1.0 k $\Omega$ , 5%, 0.1 W, 0603   | 0603                 | RC0603JR-071KL      | Yageo               |
| R5   | 1   | 4.7 k $\Omega$  | RES, 4.70 k $\Omega$ , 1%, 0.063 W, 0402  | 0402                 | CRG0402F4K7         | TE Connectivity     |
| R30, R31   | 2   | 2.2 k $\Omega$  | RES, 2.2 k $\Omega$ , 5%, 0.1 W, 0603   | 0603                 | RC0603JR-072K2L     | Yageo               |
| R34, R36   | 2   | 10.0 k $\Omega$ | RES, 10.0 k $\Omega$ , 1%, 0.1 W, 0603  | 0603                 | RCG060310K0FKEA     | Vishay Draloric     |

Table 2-1. BOM (continued)

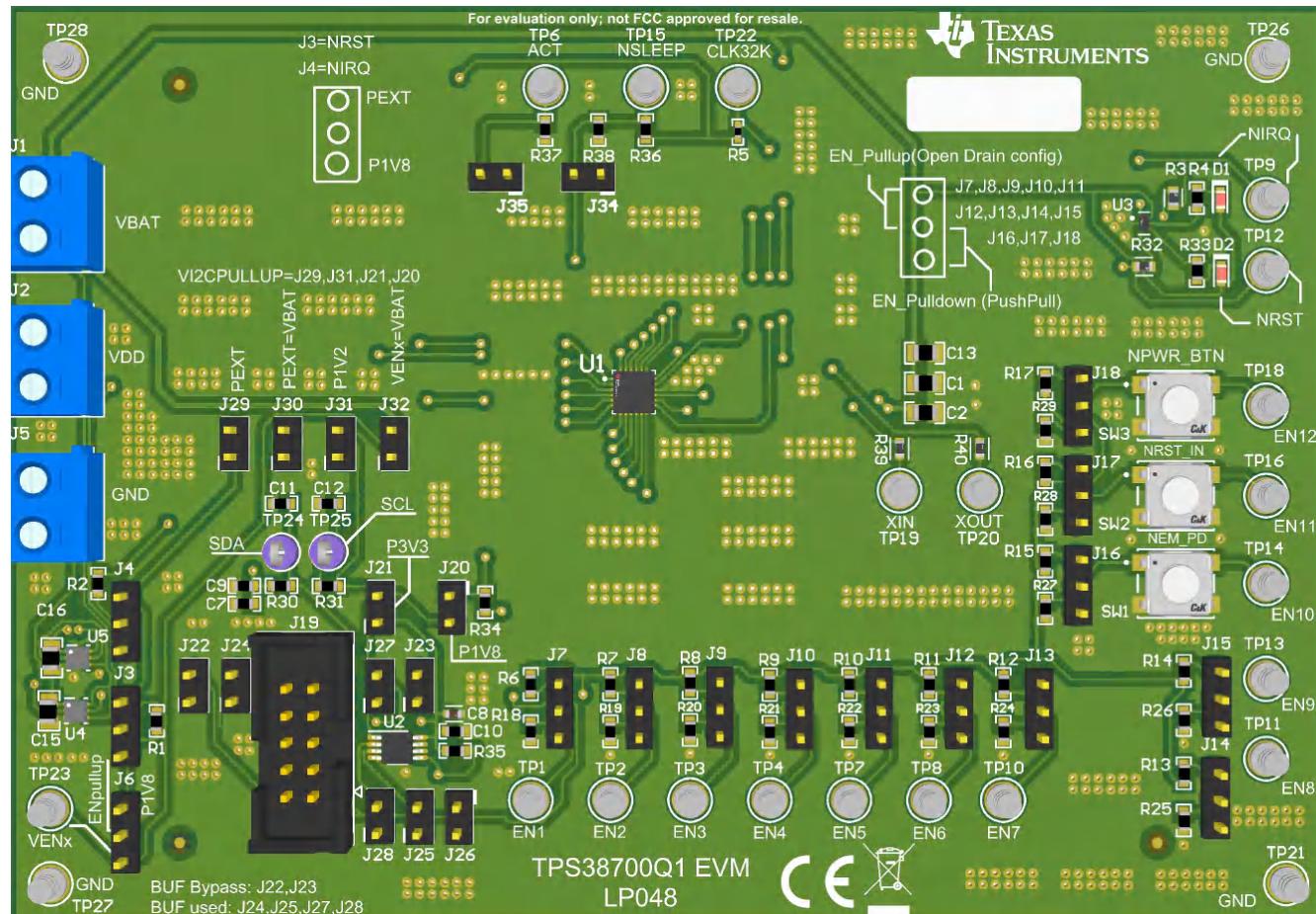
| DESIGNATOR   | QTY | VALUE   | DESCRIPTION  | PACKAGE<br>REFERENCE | PART NUMBER                | MANUFACTURER      |
|--|-----|---------|--|----------------------|----------------------------|-------------------|
| R35  | 1   | 1.0 kΩ  | RES, 1.0 kΩ, 5%, 0.1 W, AEC-Q200 Grade 0, 0603   | 0603                 | CRCW06031K00JNEA           | Vishay-Dale       |
| R37, R38   | 2   | 21.0 kΩ | RES, 21.0 kΩ, 1%, 0.1 W, 0603  | 0603                 | RC0603FR-0721KL            | Yageo             |
| R39, R40   | 2   | 0 Ω     | 0 Ω Jumper 0.1 W, 1/10 W Chip Resistor 0603 (1608 Metric) Automotive AEC-Q200 Thick Film   | 0603                 | ERJ-3GEY0R00V              | Panasonic         |
| SW1, SW2, SW3  | 3   |         | Switch Tactile N.O. SPST Round Button J-Bend 32VAC 32 VDC 1VA 100000Cycles 3N SMD Tube/T/R | SMD                  | KT11P3JM34LFS              | C&K Components    |
| TP1, TP2, TP3, TP4, TP6, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP15, TP16, TP18, TP19, TP20, TP21, TP22, TP23, TP26, TP27, TP28 | 24  |         | Terminal, Turret, TH, Triple   | TH                   | 1598-2                     | Keystone          |
| TP24, TP25   | 2   |         | Test Point, Multipurpose, Purple, TH   | TH                   | 5129                       | Keystone          |
| U2   | 1   |         | Automotive, Level-Shifting I2C Bus Repeater, DGK0008A (VSSOP-8)                            | VSSOP-8              | TCA9517DGKRQ1              | Texas Instruments |
| U3   | 1   |         | Dual-Channel, Low-Power Comparator with Integrated Reference (USON)                        | USON                 | TLV4082DRYR                | Texas Instruments |
| U4   | 1   |         | 1 A Low-Quiescent-Current Low-Dropout (LDO) Regulator, DRV0006A (WSON-6)                   | WSON-6               | TLV75712PDRVR              | Texas Instruments |
| U5   | 1   |         | 1 A Low-Quiescent-Current Low-Dropout (LDO) Regulator, DRV0006A (WSON-6)                   | WSON-6               | TLV75718PDRVR              | Texas Instruments |
| U1   | 1   |         | ASIL-B Multichannel I2C Programmable Voltage Sequencer (VQFN)                              | VQFN                 | TPS38700C03NRGERQ1         | Texas Instruments |
| Y1   | 1   |         | Crystal, 32.768 kHz, 12.5 pF, SMD  | SMD                  | NX3215SA-32.768K-STD-MUA-8 | NDK               |

## 2.3 Layout and Component Placement

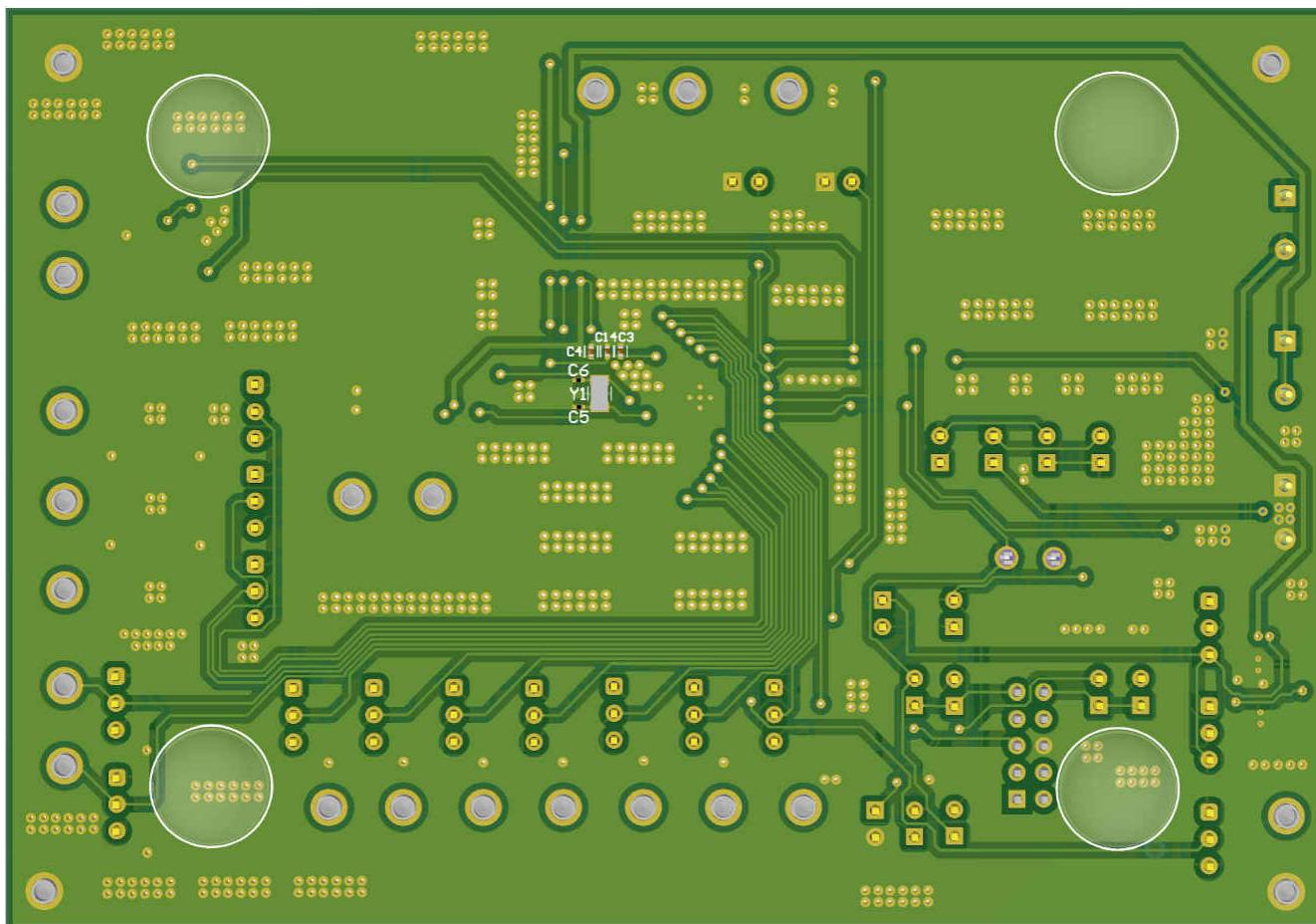
Figure 2-3 and Figure 2-4 show the top and bottom assemblies of the printed circuit board (PCB) to show the component placement on the EVM.

Figure 2-5 and Figure 2-6 show the top and bottom layouts, Figure 2-7 and Figure 2-8 show the top and bottom layers, and Figure 2-9 shows the top solder mask of the EVM.

## 2.4 Layout



**Figure 2-3. Component Placement—Top Assembly**



**Figure 2-4. Component Placement—Bottom Assembly**

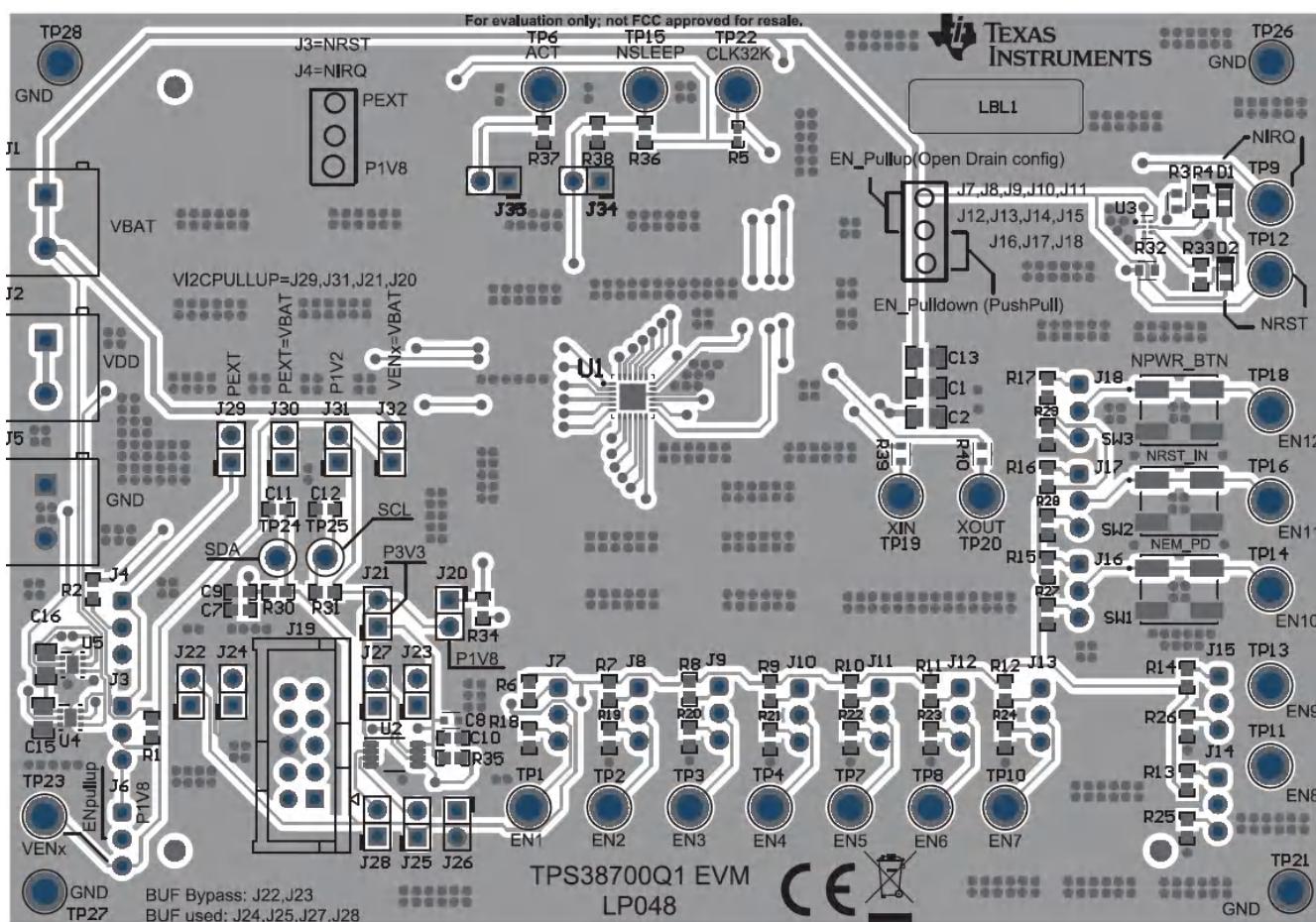


Figure 2-5. Layout—Top

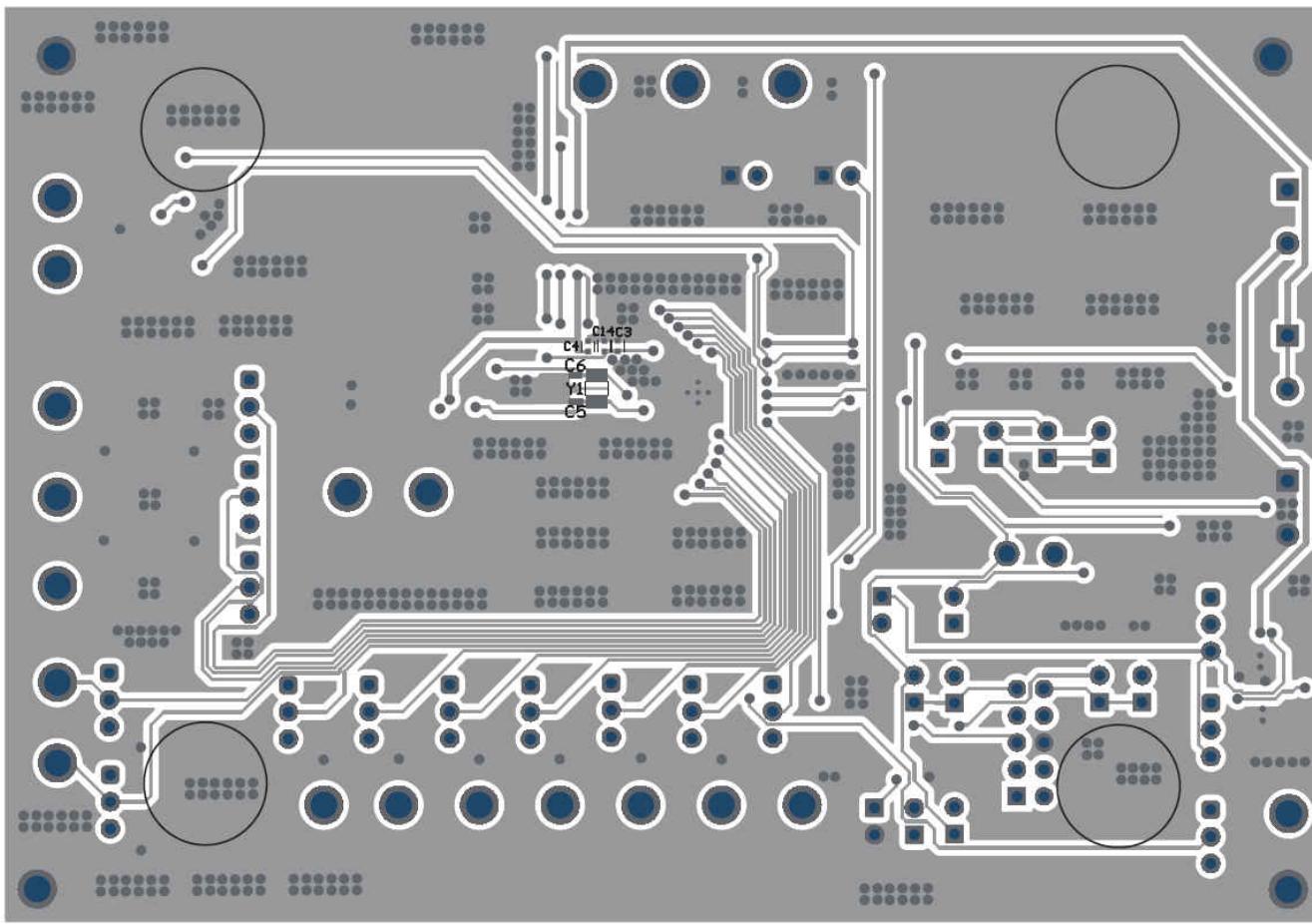
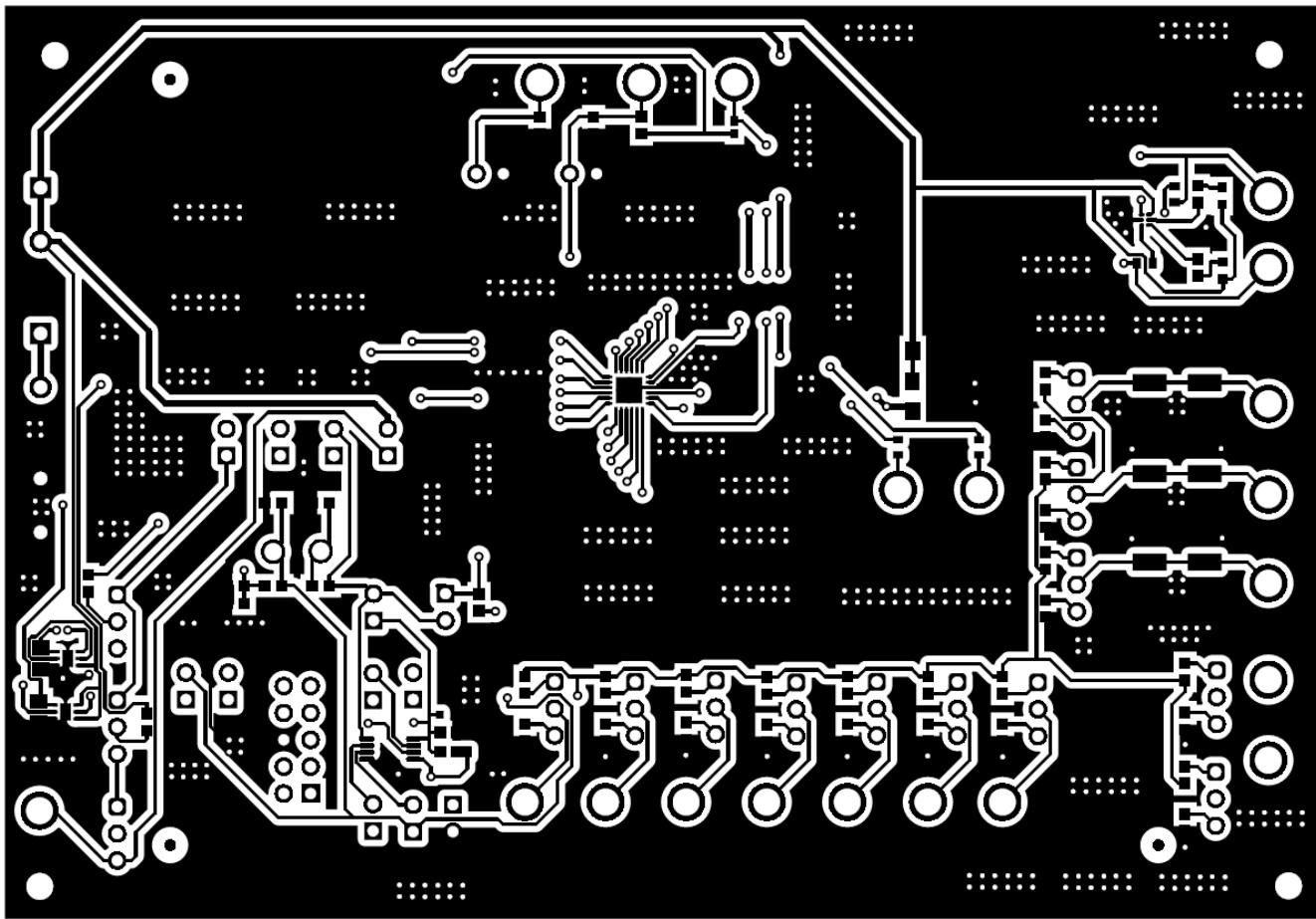


Figure 2-6. Layout—Bottom



**Figure 2-7. Top Layer**

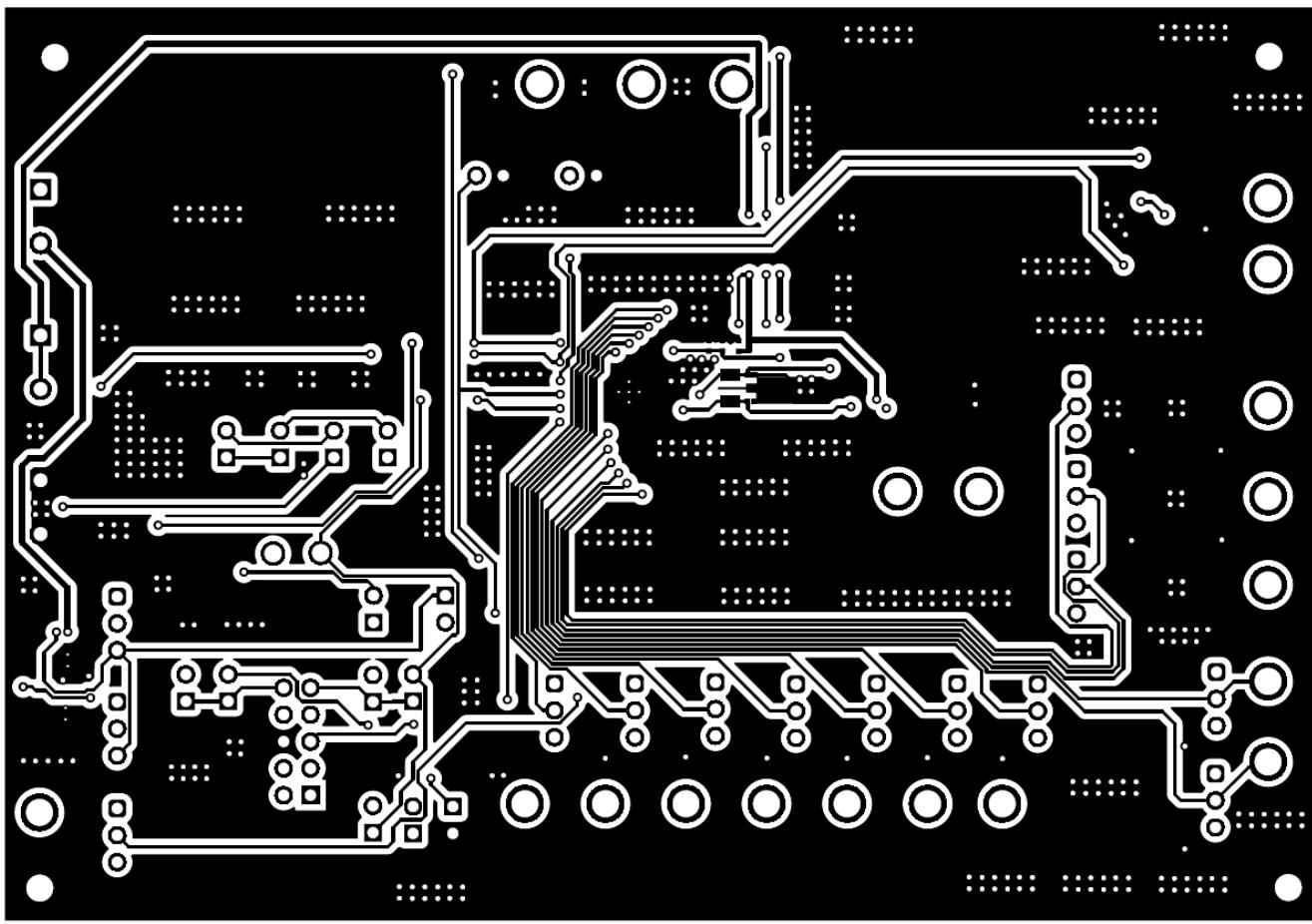


Figure 2-8. Bottom Layer

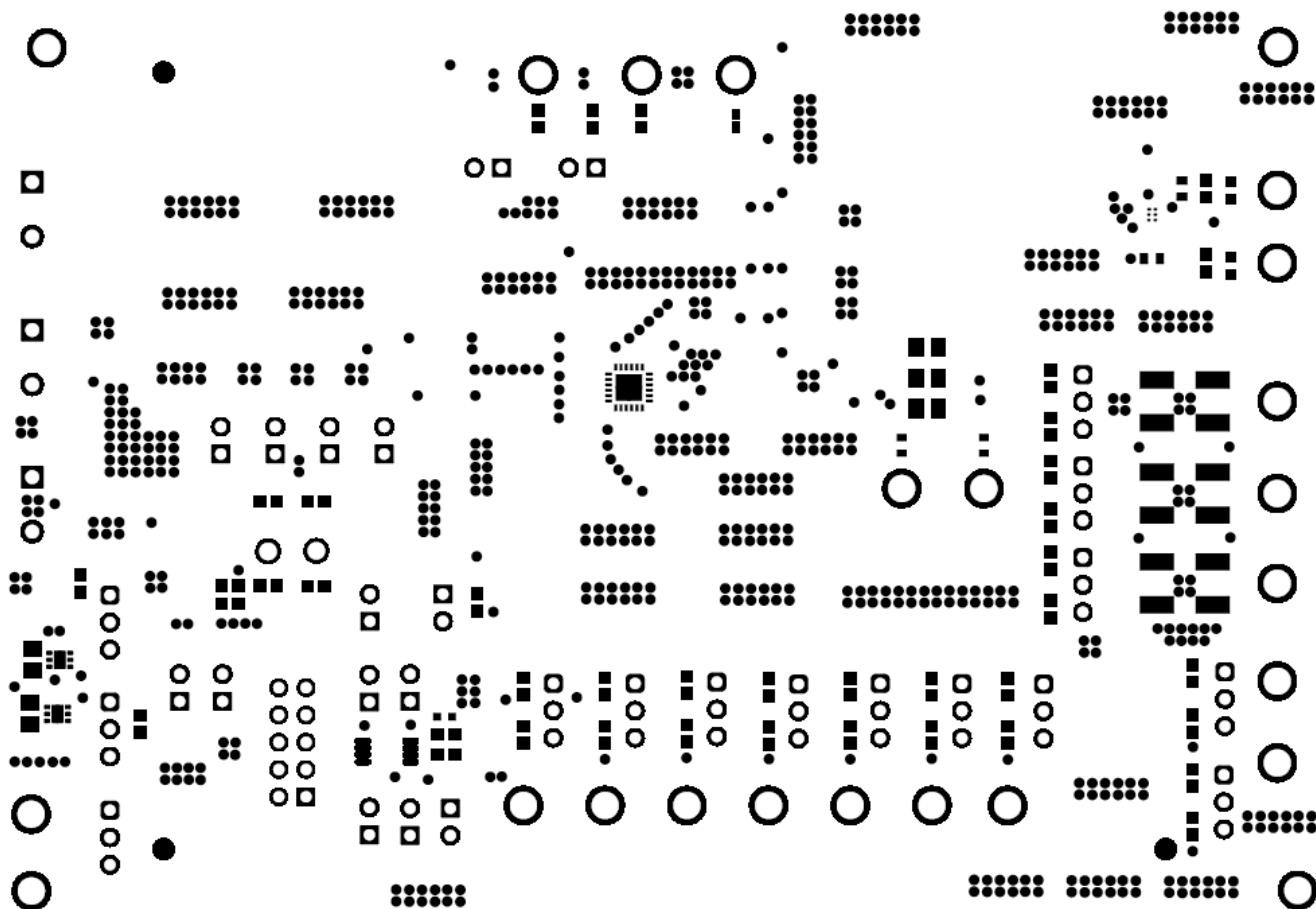


Figure 2-9. Top Solder Mask

## 3 EVM Connectors

This section describes the connectors, jumpers, and test points on the EVM as well as how to connect, set up, and properly use the EVM. Each device has an independent supply connection, but all grounds are connected on the board.

### 3.1 EVM Test Points

**Table 3-1** lists the EVM test points as well as their functional descriptions. All TPS38700-Q1 pins have a corresponding test point on the EVM. These test points are located close to the pins for more accurate measurements. In addition to the test points listed below, the EVM also has four additional GND test points.

**Table 3-1. Test Points**

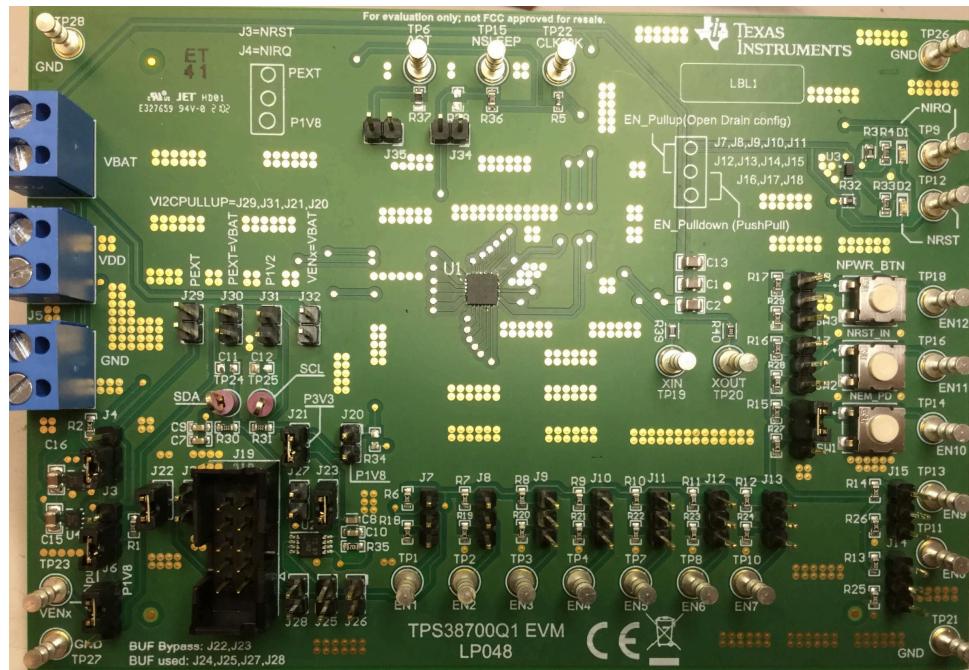
| TEST POINT NUMBER | TEST POINT SILKSCREEN LABEL | FUNCTION  | DESCRIPTION  |
|-------------------|-----------------------------|---|--|
| TP1               | EN1                         | Connection to EN1 pin                             | Allows the user to monitor the SENSE1 pin                                    |
| TP2               | EN2                         | Connection to EN2 pin                             | Allows the user to monitor the EN2 pin                                       |
| TP3               | EN3                         | Connection to EN3 pin                             | Allows the user to monitor the EN3 pin                                       |
| TP4               | EN4                         | Connection to EN4 pin                             | Allows the user to monitor the EN4 pin                                       |
| TP6               | ACT                         | Connection to ACT pin                             | Allows the user to set ACT input   |
| TP7               | EN5                         | Connection to EN5 pin                             | Allows the user to monitor the EN5 output                                    |
| TP8               | EN6                         | Connection to EN6 pin                             | Allows the user to monitor the EN6 output                                    |
| TP9               | NIRQ                        | Connection to NIRQ pin                            | Allows the user to monitor the NIRQ output                                   |
| TP10              | EN7                         | Connection to EN7 pin                             | Allows the user to monitor the EN7 output                                    |
| TP11              | EN8                         | Connection to EN8 pin                             | Allows the user to monitor the EN8 output                                    |
| TP12              | NRST                        | Connection to NRST pin                            | Allows the user to monitor the NRST output                                   |
| TP13              | EN9                         | Connection to EN9 pin                             | Allows the user to monitor the EN9 output                                    |
| TP14              | EN10/NEM_PD                 | Connection to EN10 pin and Emergency Shutdown pin | Allows the user to monitor the EN10 output                                   |
| TP15              | SLEEP                       | Connection to SLEEP pin                           | Allows the user to set SLEEP input   |
| TP16              | EN11/NRST_IN                | Connection to EN11 pin and Reset In               | Allows the user to monitor the EN11 output                                   |
| TP18              | EN12/NPWR_BTN               | Connection to EN12 pin and Power Button           | Allows the user to monitor the EN12 output                                   |
| TP21              | GND                         | GND for EVM                                       | GND for EVM  |
| TP22              | CLK32K                      | Connection to CLK32K pin                          | Allows the user to monitor the CLK32K output                                 |
| TP23              | VENx                        | Connection to External Voltage                    | Allows the user to connect to an external voltage for pulling up enable pins |
| TP26              | GND                         | GND for EVM                                       | GND for EVM  |
| TP27              | GND                         | GND for EVM                                       | GND for EVM  |
| TP28              | GND                         | GND for EVM                                       | GND for EVM  |

### 3.2 EVM Jumpers

Table 3-2 lists the jumpers on the TPS38700Q1EVM. As ordered, the EVM will have sixteen (16) jumpers installed. Figure 3-1 is provided as visual aid.

**Table 3-2. List of On-board Jumpers**

| JUMPER              | DEFAULT JUMPER CONFIGURATION | DESCRIPTION   |
|---------------------|------------------------------|---|
| J1                  | VBAT                         | For connecting VBAT power to the EVM  |
| J2                  | VDD                          | For connecting VDD power to the EVM   |
| J3 & J4             | Shunt to bottom position     | For connecting NRST and NIRQ to P1V8 or PEXT (Any external power)   |
| J5                  | GND                          | For connecting GND to the EVM   |
| J6                  | P1V8                         | For pulling- up ENABLE pins to P1V8 or VENx (Any external voltage)  |
| J7 - J18            | No connect                   | For pulling-up or down ENABLE pins (Only for open-drain configuration)/No connection for push-pull configuration  |
| J16                 | Shunt to top position        | For pulling-up EN10 pin to P1V8.  |
| J19                 | Connect                      | For connecting the EVM to TI's USB Interface Adapter  |
| J20, J29, & J31     | No connect                   | For connecting the on-board buffer to either P1V8, PEXT or P1V2. Only shunt one of these jumpers when using the buffer. Please remove the shunt of J21 when using one of these jumpers. |
| J21                 | Shunt                        | For connecting the on-board buffer IC to P3V3   |
| J22 & J23           | Shunt                        | For I2C lines to bypass buffer.   |
| J24, J25, J27 & J28 | No connect                   | For I2C lines to use the on-board buffer.   |
| J30                 | No connect                   | For connecting VBAT to PEXT   |
| J32                 | No connect                   | For connecting VENx to VBAT   |
| J34 & J35           | No connect                   | For manually pulling down NSLEEP and ACT pins   |



**Figure 3-1. Jumper Settings**

## 4 EVM Setup and Operation

This section describes the functionality and operation of the TPS38700Q1EVM. Refer to the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#) data sheet for details on the electrical characteristics of the device.

The TPS38700Q1EVM comes pre-populated with the TPS38700C03NRGERQ1. The EVM is capable of many different configurations in order to fully evaluate the functionality of all the TPS38700-Q1 device variants. The default configuration of the EVM Jumpers is mentioned in the [Table 3-2](#). The TPS38700Q1EVM comes populated with I2C bus repeater, comparators, LDO, 32.768 kHz crystal and TPS38700C03NRGERQ1 programmable voltage sequencer.

The TPS38700Q1EVM also provides an option to apply a separate pull-up voltage to any of the ENABLE pins by changing the position of jumper J6 to VENx and connecting the pull-up voltage to test points TP23.

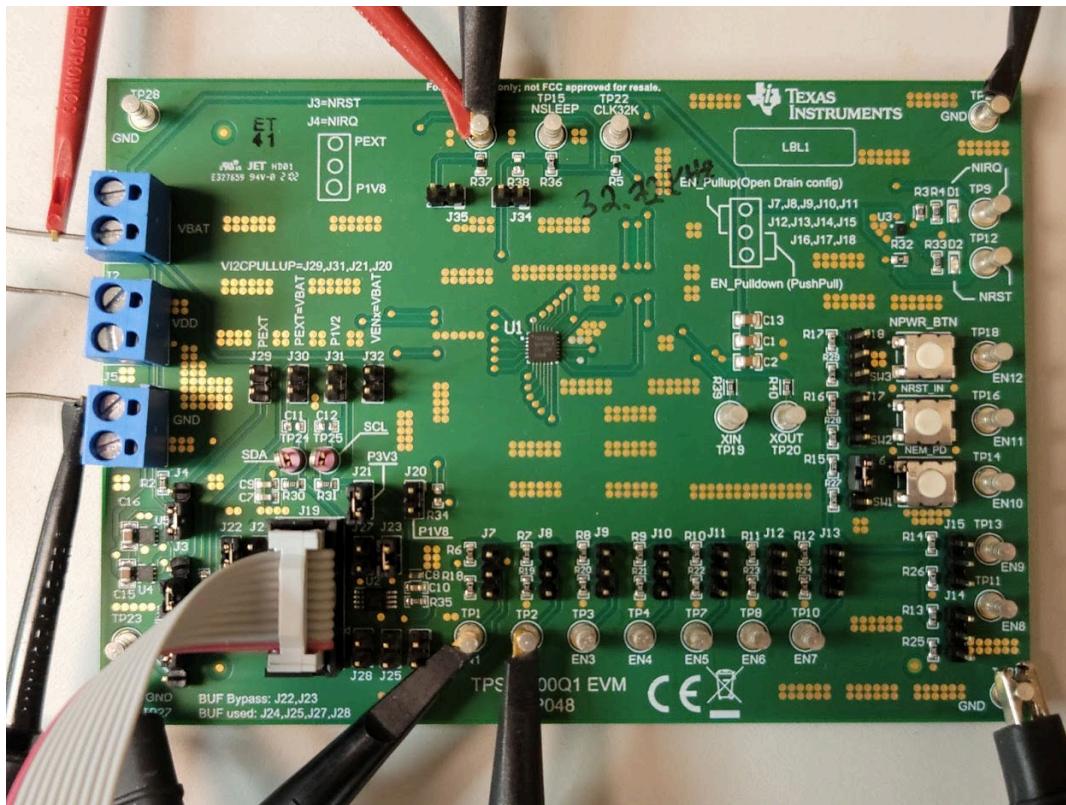
### Equipment Needed

- TPS38700Q1EVM
- TI's USB Interface Adapter (with ribbon cable)
- Power Supply (3.3 V)
- Function Generator (provide pulse input for evaluation)
- Multi-channel Oscilloscope (review evaluation waveforms)
- Jumper Cables (additional evaluation)

### 4.1 Setup and GUI Installations

Follow the steps below for EVM connections and GUI installation:

1. Connect VBAT (J1) and VDD (J2) to 3.3 V from the power supply.
2. Connect GND (J5) to ground from the power supply.
3. Make sure the jumpers are connected as per the guidelines in the [Table 3-2](#).
4. Power on the power supply briefly to check if the voltage is at 3.3 V and the quiescent current is at 10 mA. Once reviewed, power down the power supply.
5. Connect the Oscilloscope's channel 1 to TP1, channel 2 to TP2, and channel 3 to TP6.
6. Connect the function generator to TP6.
7. Connect the TI's USB Interface Adapter to J19 using a ribbon cable.
8. Connect the TI's USB Interface Adapter to the computer using the USB.
9. Final connections should look similar to [Figure 4-1](#).



**Figure 4-1. EVM Connections for Testing EN1 and EN2**

10. Install the GUI.

- Download the [Fusion Digital Power Designer](#) Platform GUI for TPS38700Q1EVM
- Open the downloaded file.
- In the Welcome Wizard window, click Next.

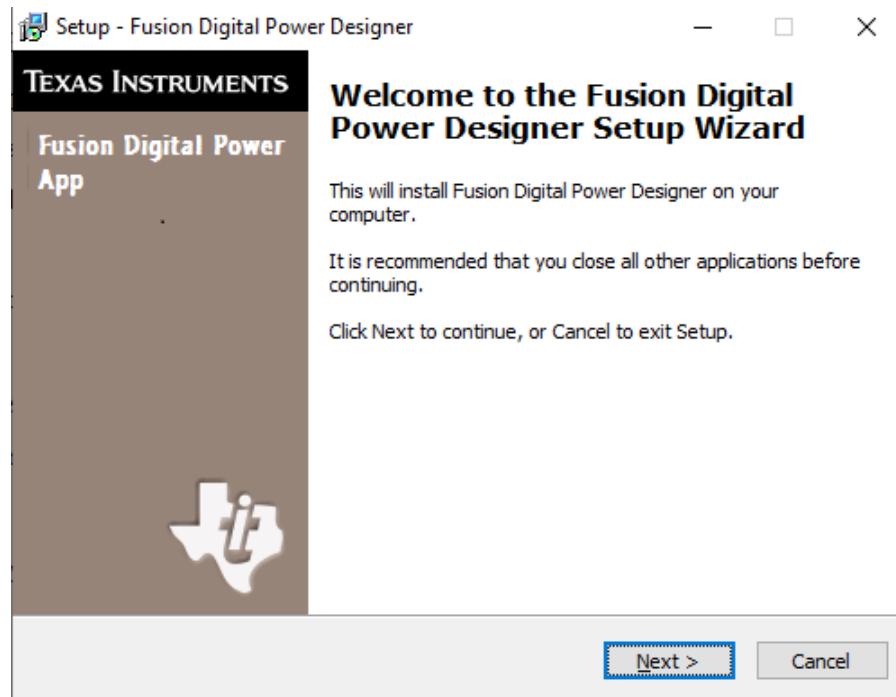


Figure 4-2. Welcome Setup Window

- Accept the license agreement and then click Next.

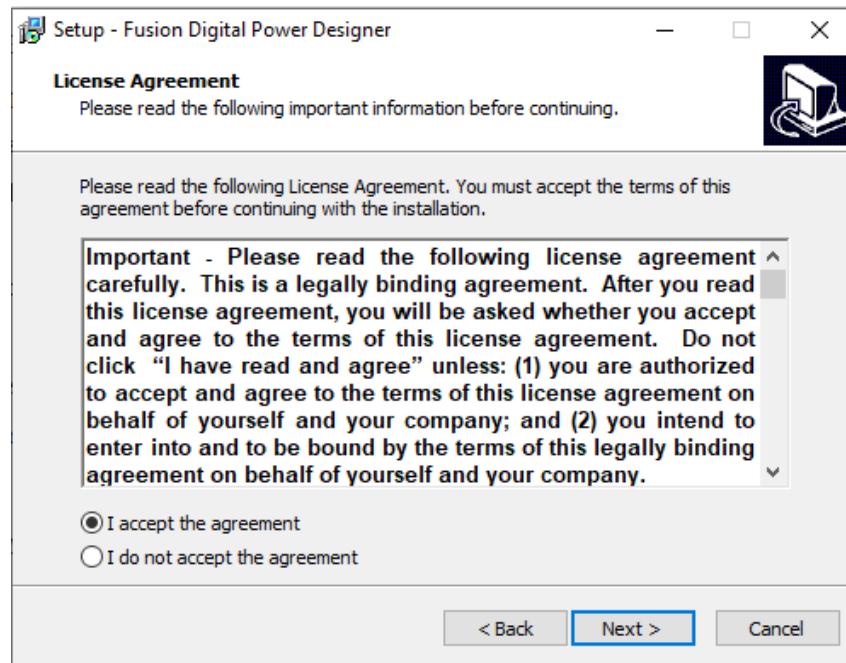
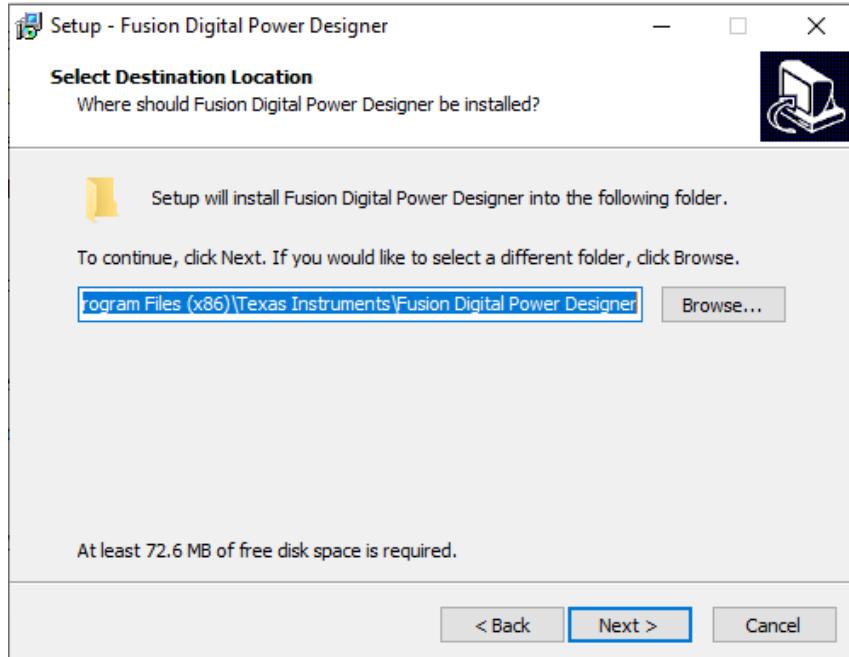


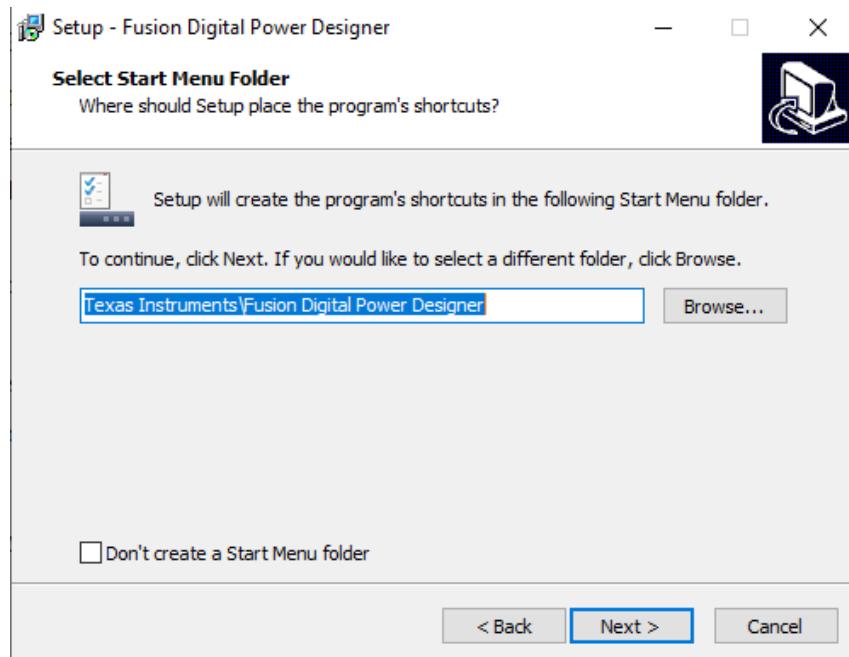
Figure 4-3. Setup License Agreement Window

e. The default destination folder works best. Click Next.



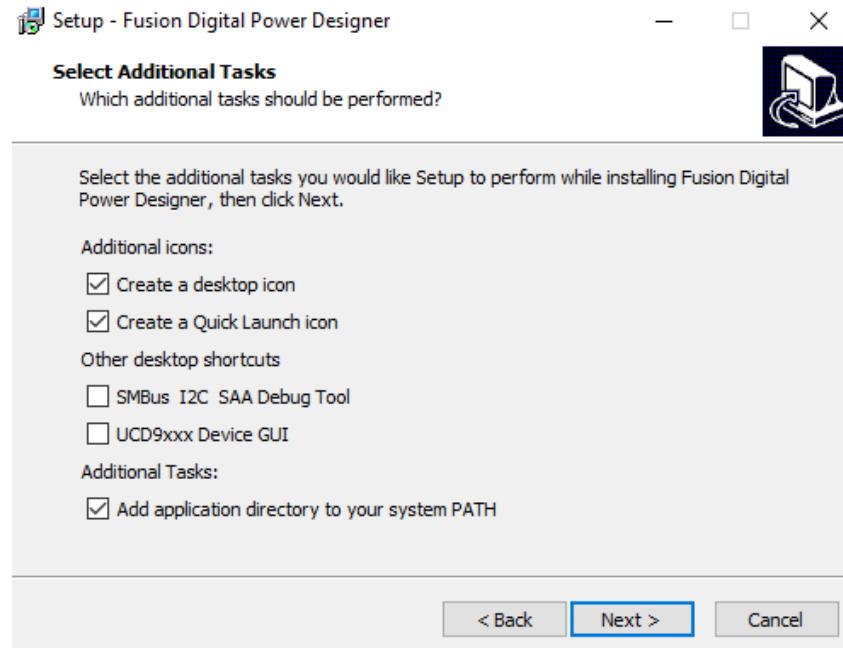
**Figure 4-4. Setup Destination Window**

f. Click Next for the Select Start Menu Folder option.



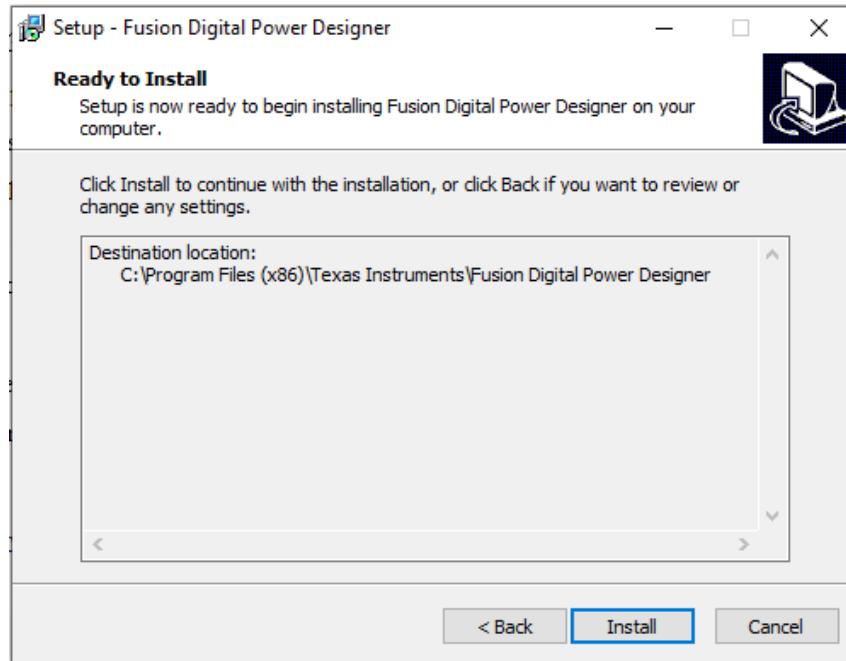
**Figure 4-5. Setup Window - Start Menu Selection**

g. There is no need to install additional options for this EVM. Click Next.



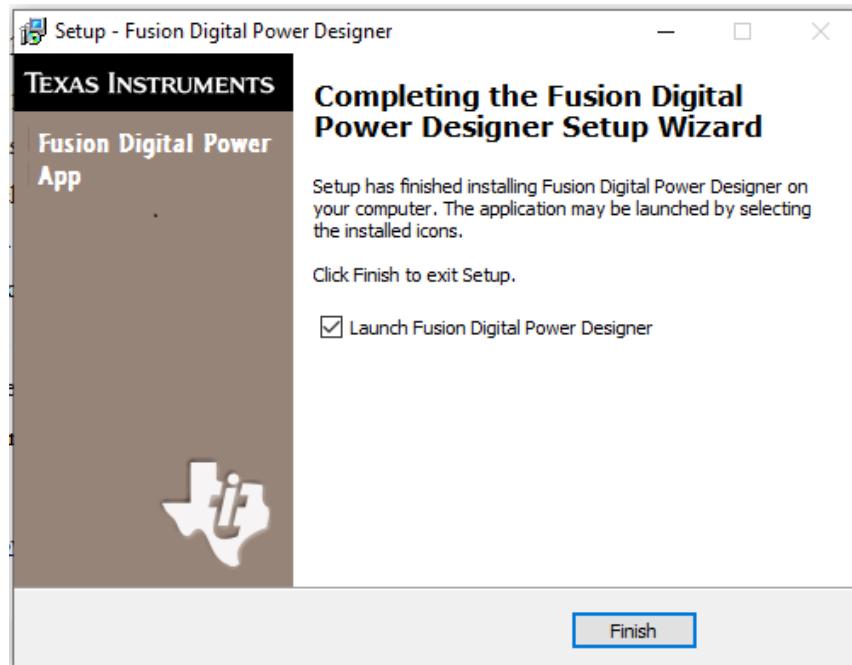
**Figure 4-6. Setup Window - Additional Tasks**

h. Finally click Install to install the Fusion software.



**Figure 4-7. Setup Installation Window**

- i. Click on Finish to complete the installation setup and launch the software.



**Figure 4-8. Installation Complete Window**

## 4.2 GUI

This section shows the graphical user interface (GUI) the user will use to interact with the EVM. Refer to the [TPS38700-Q1 Multichannel I2C Programmable Voltage Sequencer](#) datasheet for details on the register description of the device.

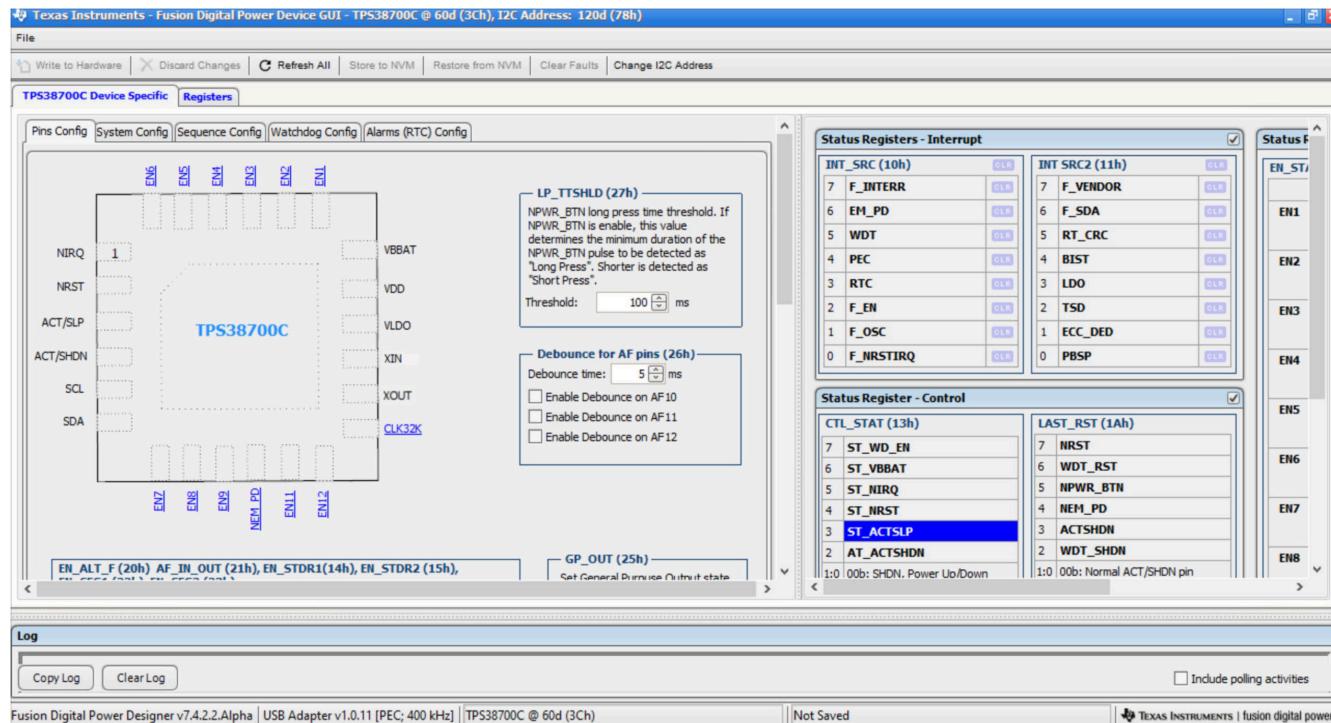


Figure 4-9. Main GUI Screen

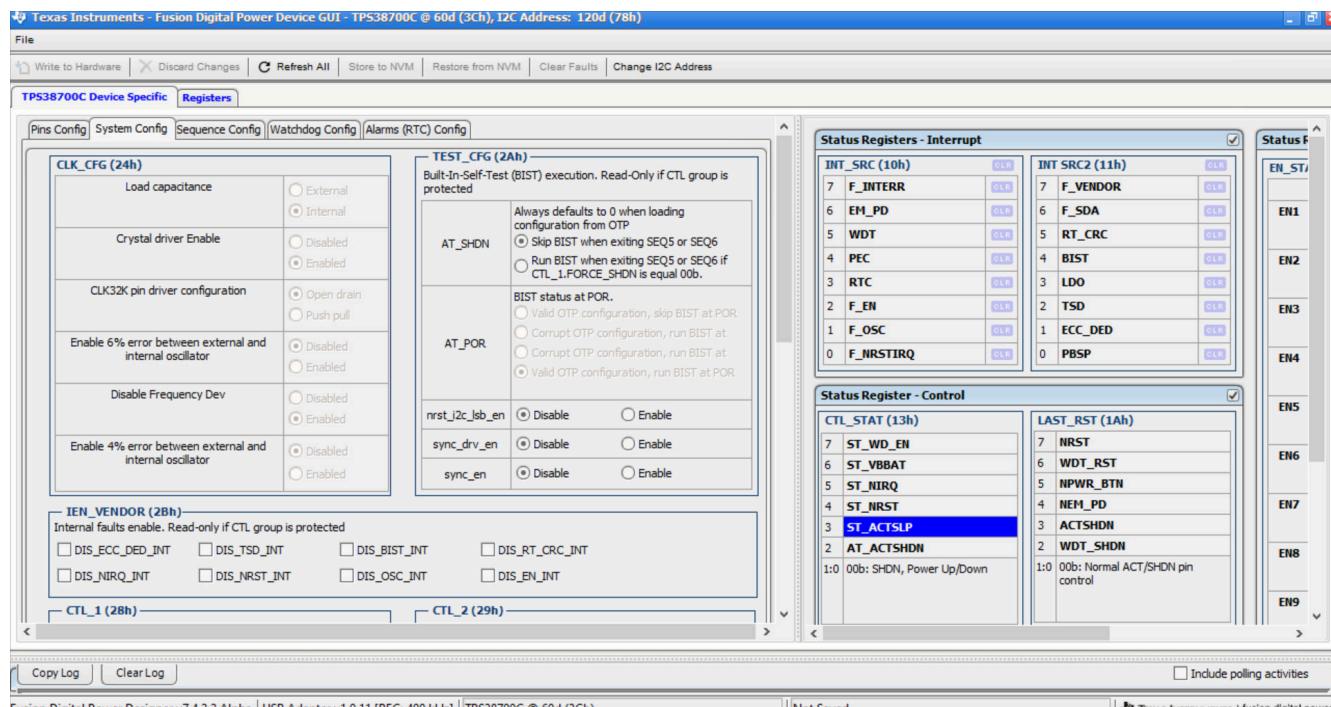
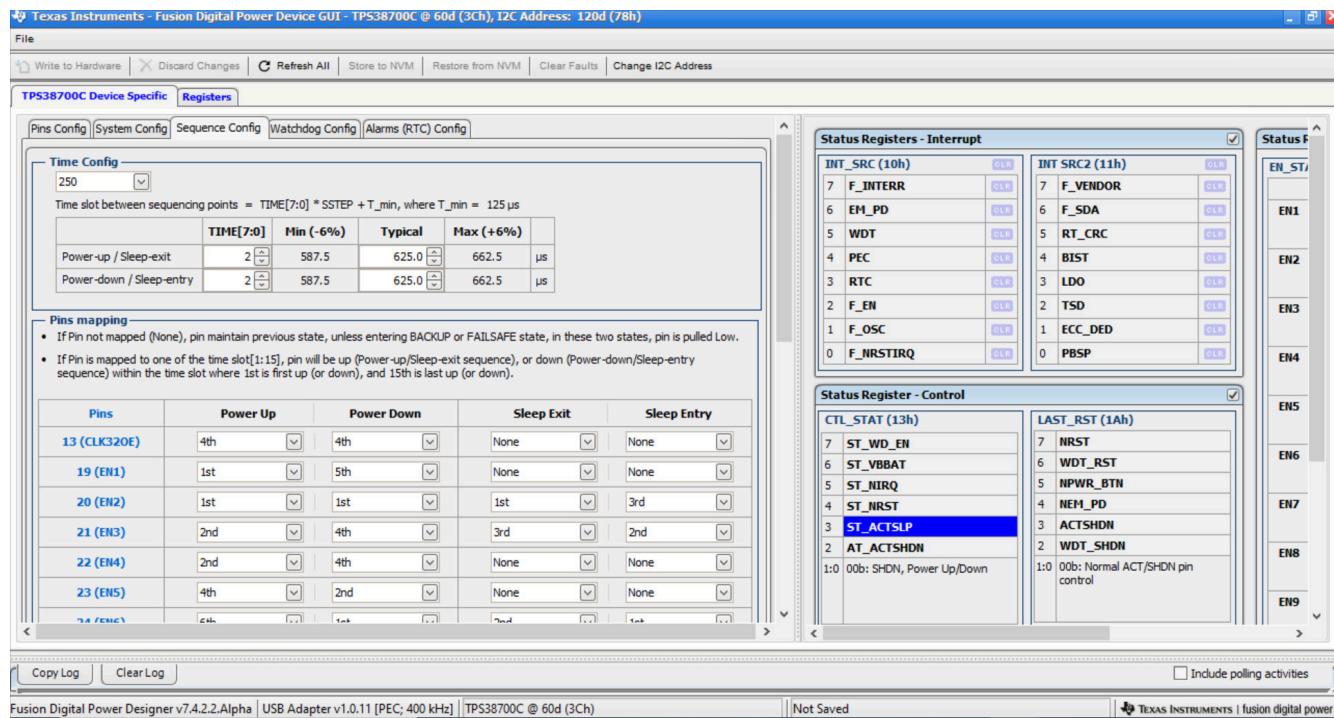
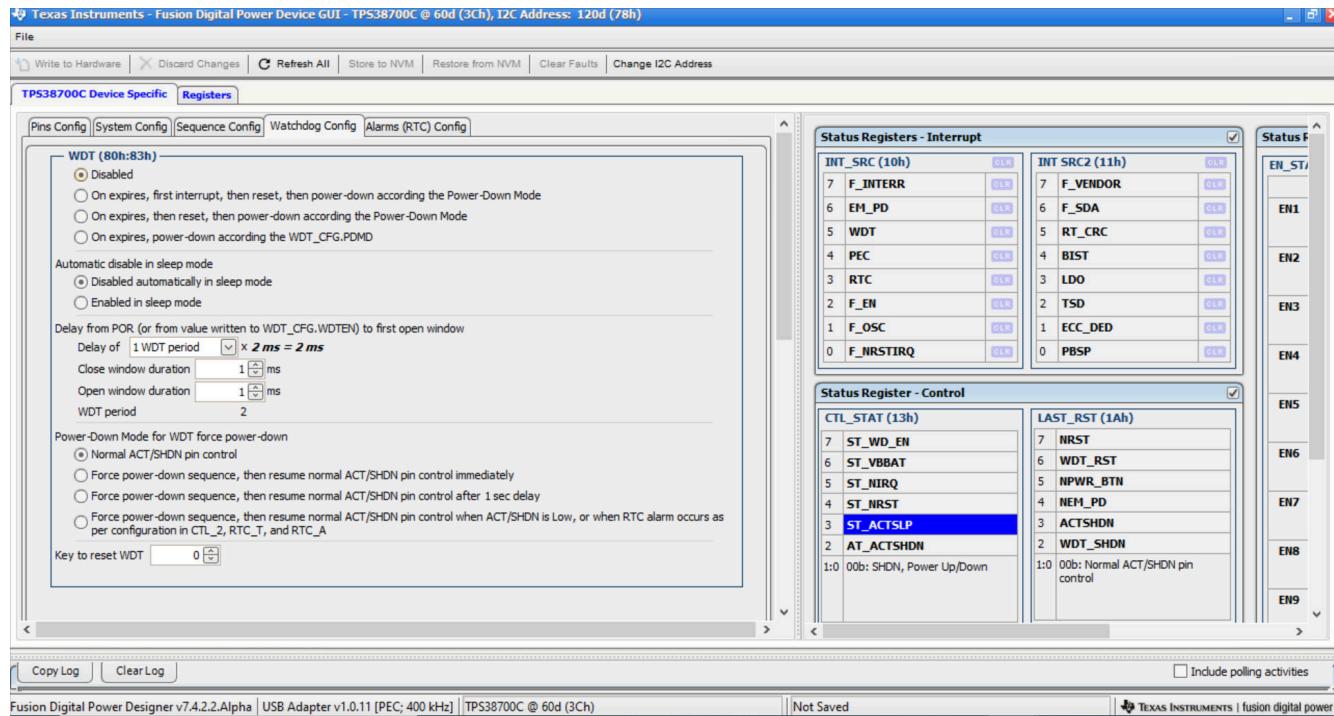
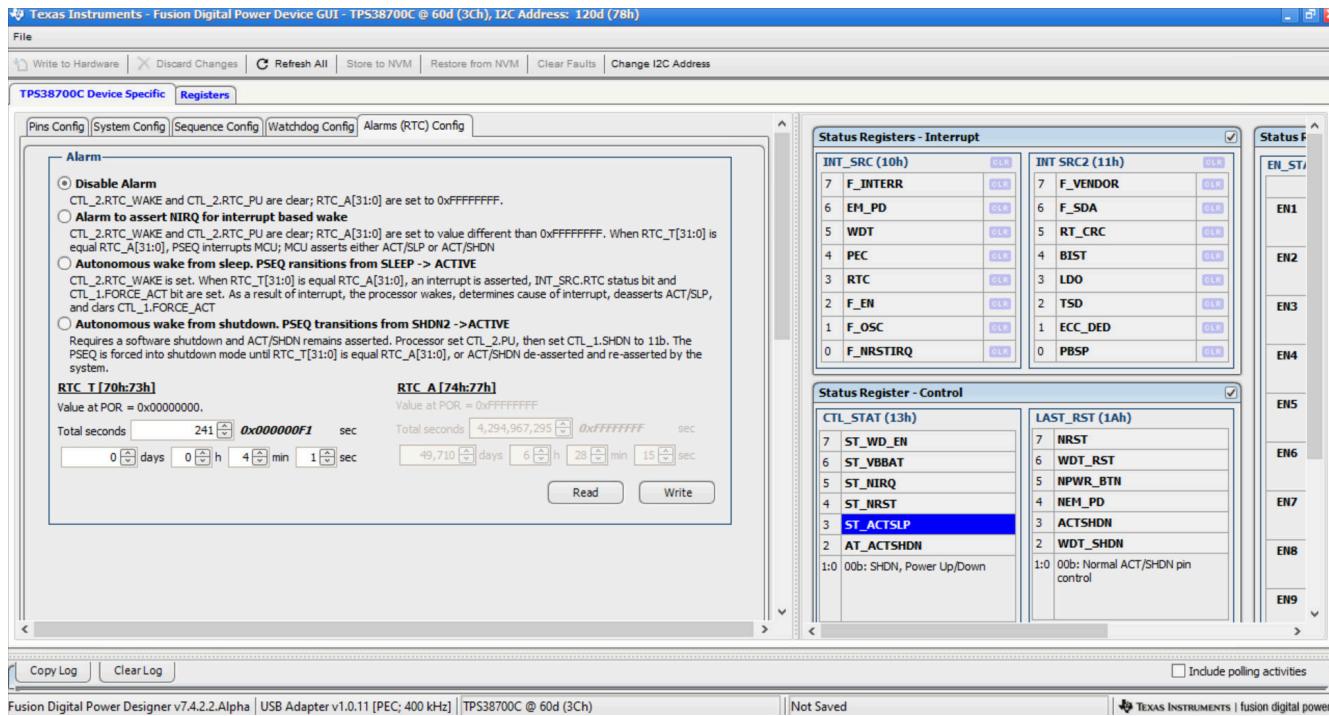
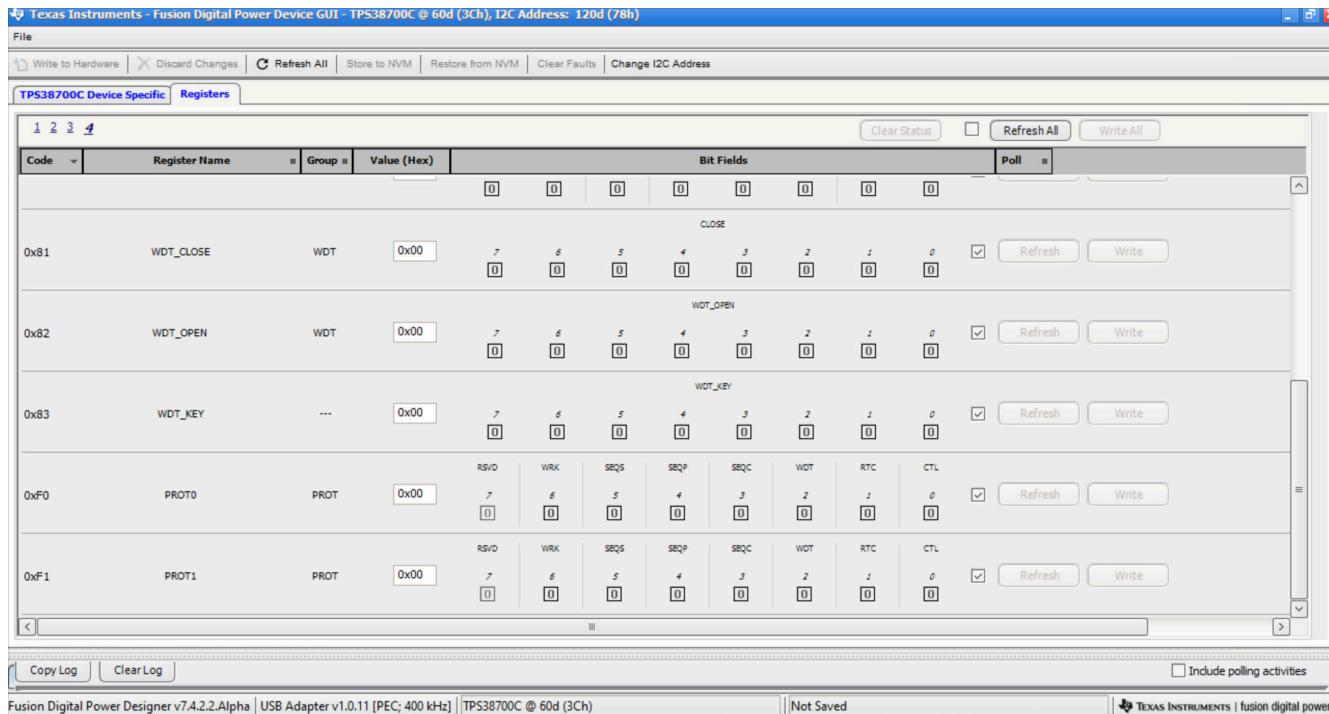


Figure 4-10. System Config

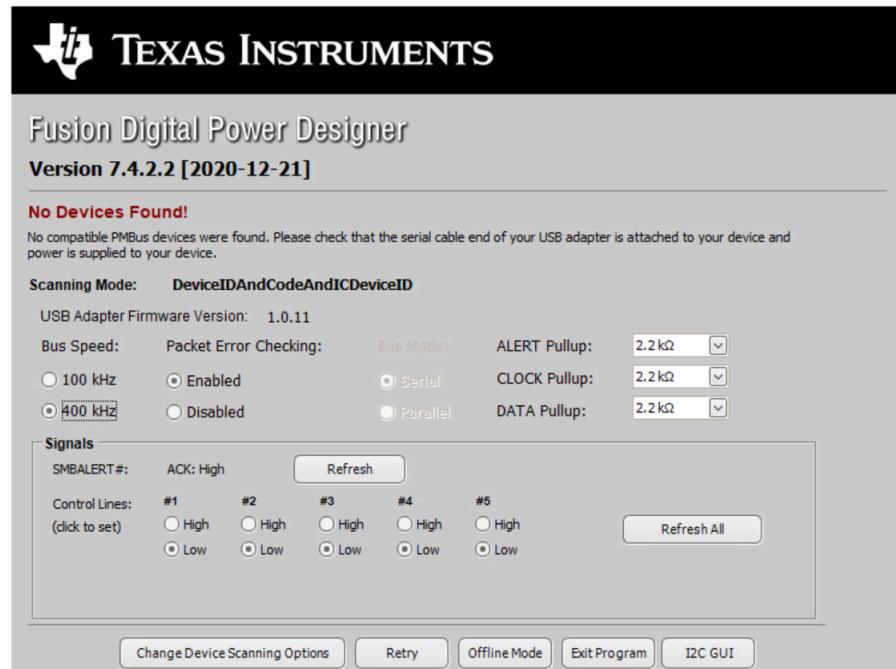

**Figure 4-11. Sequence Config**

**Figure 4-12. Watchdog Config**


**Figure 4-13. Alarms Config**

**Figure 4-14. Registers**

## 4.3 Quick Start

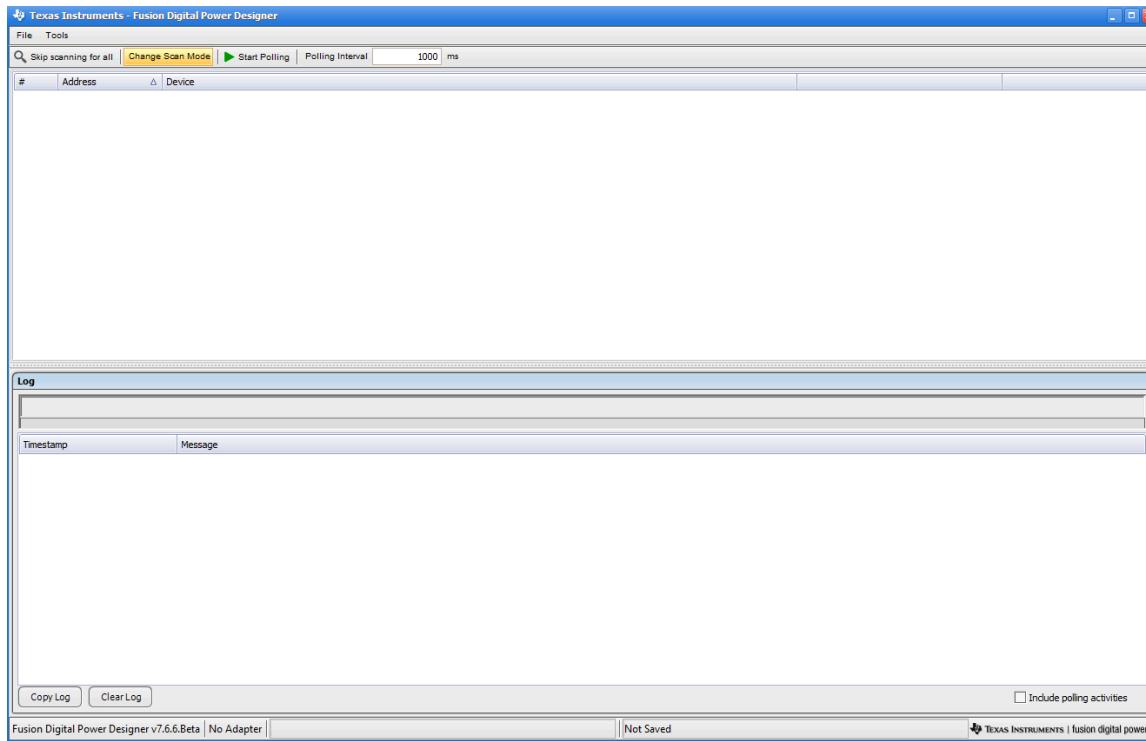
Follow the steps below precisely to quickly evaluate the TPS38700-Q1. In this quick start, we will be looking at Enable 1 and Enable 2 signals after the ACT pin is triggered.

1. Make the connections described in [Section 4.1](#). Skip the GUI installation if the TPS38700Q1EVM GUI is already installed.
2. Power the EVM by turning on the power supply. Note that the voltage and current at the supply are 3.3 V and 10 mA.
3. Once the TI's USB Interface Adapter is connected to EVM and the laptop, launch the evaluation software Fusion Digital Power Designer.
4. Click on I2C GUI in the bottom right.

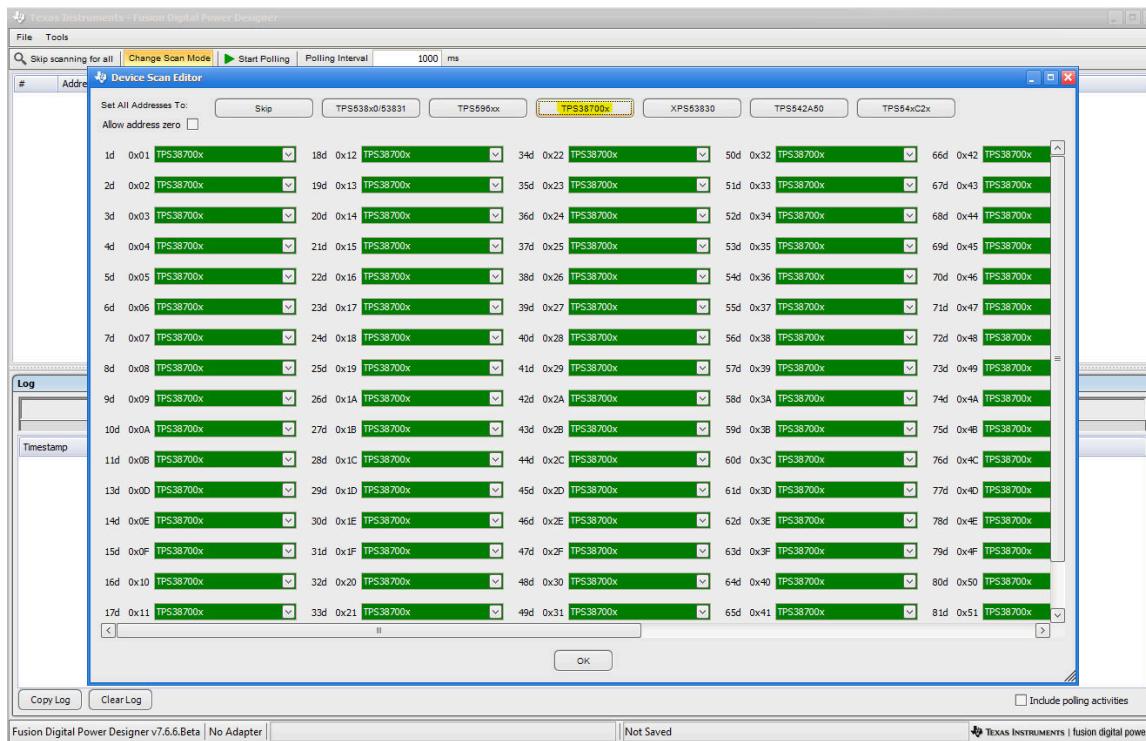


**Figure 4-15. Fusion Welcome Window**

5. Click on Change Scan Mode to select TPS38700x and then click OK.

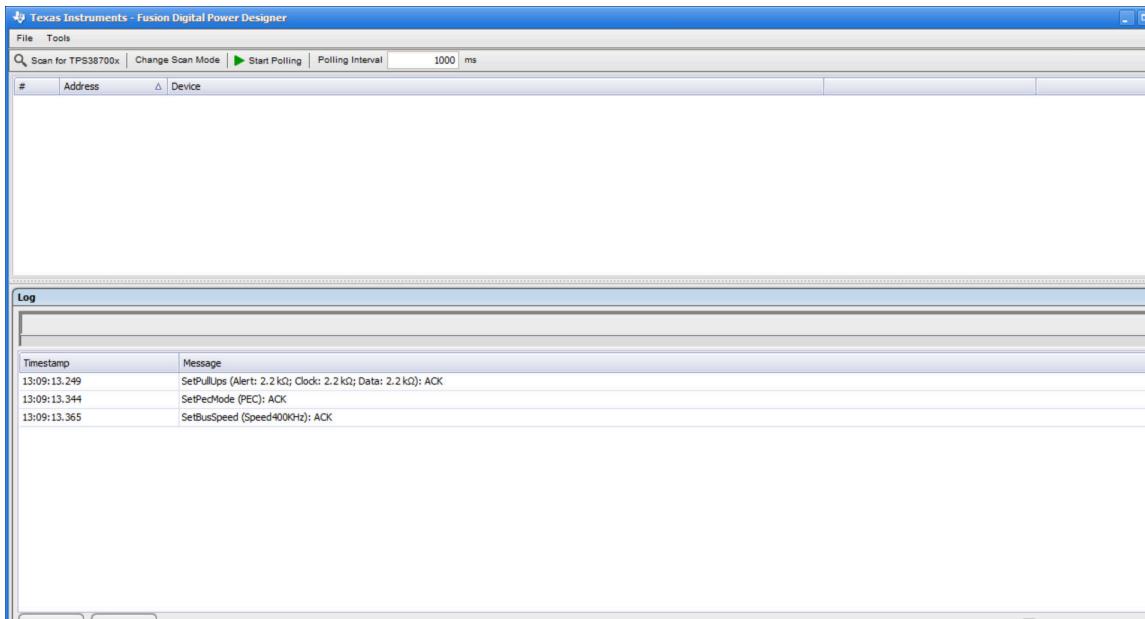


**Figure 4-16. Fusion Scan Window**



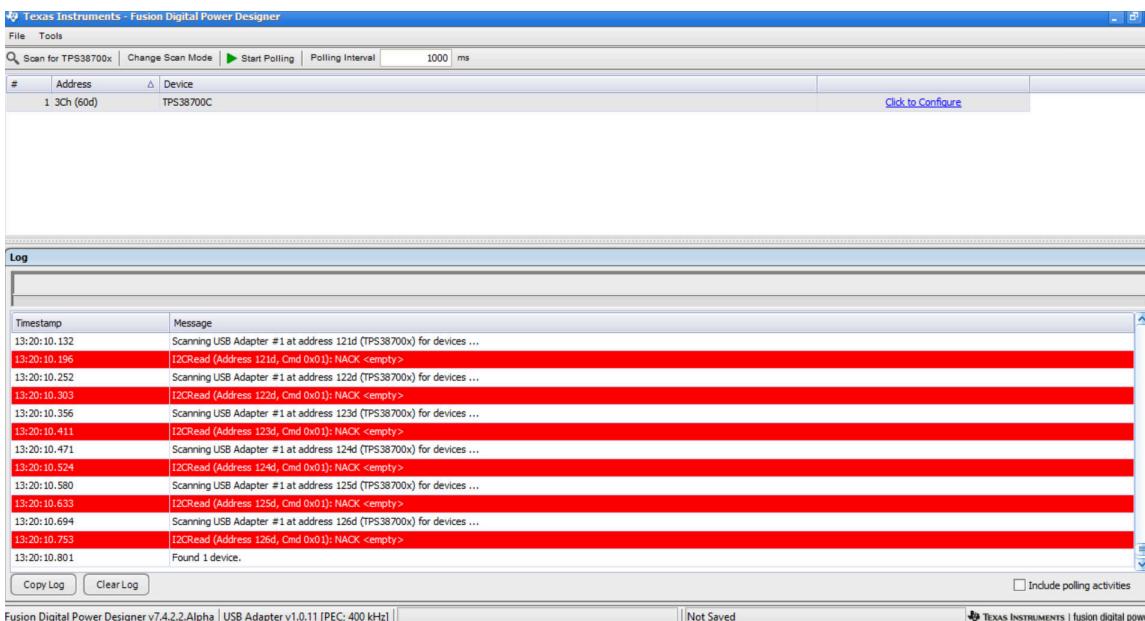
**Figure 4-17. Fusion Scan Selection Window**

6. Scan for the TPS38700Q1EVM by clicking on "Scan for TPS38700x" on top left of the window.



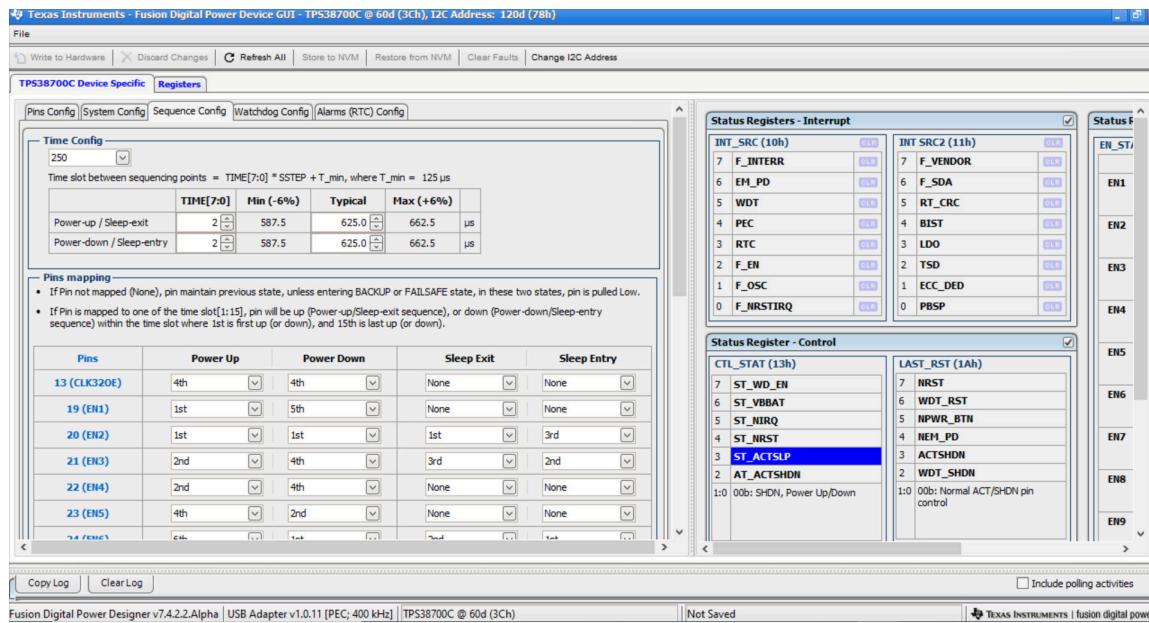
**Figure 4-18. Fusion Scan Window - Scanning for TPS38700Q1EVM**

7. Once the EVM is discovered, select Click to Configure (text in blue).



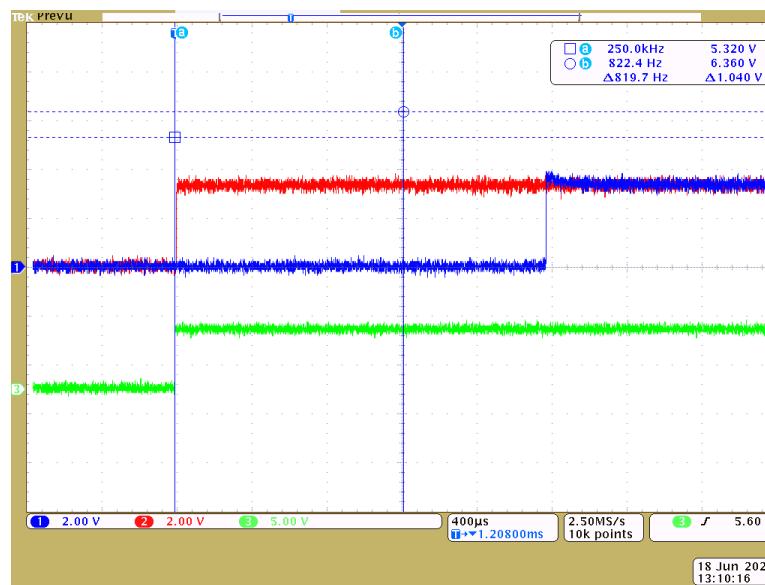
**Figure 4-19. Fusion Scan Window - Scan for TPS38700Q1EVM Completed**

8. Go to the Sequence Config tab. In the Pins mapping section, change the pin 19's (EN1) Power Up sequence from 1st to 4th sequence. Now, the Enable 1 signal is part of the 4th power-up sequence. Hence, delaying the signal by about 2 ms from Enable 2 signal (which is still part of the first power-up sequence).



**Figure 4-20. TPS38700 GUI Window - Sequence Config Tab**

9. Change the trigger in the oscilloscope from channel 1 to channel 3 to get the trigger from ACT pin.  
 10. Set the Function Generator to create a 3.3 V pulse waveform. Turn-on the output from the Function Generator connected to the ACT pin to trigger the power-up sequence.  
 11. The output at the oscilloscope should look like the [Figure 4-21](#) where green waveform is the pulse to the ACT pin (TP6), red waveform is Enable 2 signal and blue waveform is the Enable 1 Signal.



**Figure 4-21. Expected Output Signal**

## 5 Revision History

| <b>Changes from Revision A (April 2022) to Revision B (July 2023)</b> | <b>Page</b> |
|---|-------------|
| • Update to sequencer part number throughout document.....            | 3           |

| <b>Changes from Revision * (July 2021) to Revision A (April 2022)</b>                   | <b>Page</b> |
|---|-------------|
| • Edited the TPS38700Q1EVM Schematic to reflect the new TPS38700-Q1 package pinout..... | 6           |
| • First public release.....   | 19          |
| • Edited the Main GUI Screen image to reflect the new TPS38700-Q1 package pinout.....   | 25          |

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This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

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- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

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3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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